



	▶ Resource Centers	▶ Products	▶ Solutions & Services	▶ Technologies & Trends	▶ Support & Downloads
--	--------------------	------------	------------------------	-------------------------	-----------------------

• Hardware Design ▶

Product Change  
Notification Home

Login Form  
Archive Area  
Where to Buy

(PCN) Archive index

The notification records are listed below in chronological order by the post date. The most recent PCN records are listed at the top of the index table. To search, scroll up or down the index table from this point.

To view or print a listed PCN in its entirety, click on the appropriate change number in the first column of the index table. All PCNs exist in a read-only Portable Document Format (PDF).

If you would like to be notified of future product changes, please [register](#) and set up your individual profile before you leave.

25 Archive PCN(s) listed for PCI\_Bridges.

Change Number	Posted	Title/Abstract	Notification Change Type
<a href="#">D000G019</a>	Mar 5 1999, updated Apr 1 2002	<b>2nd Extension of Last Order Date for 21052-AB PCI-to-PCI Bridge</b> Revision 2 - This PCN is initiated only to change the last order date for 21052-AB from 10 January, 1999.	Product Discontinuance
<a href="#">D000G029</a>	Mar 19 1999, updated Apr 1 2002	<b>Branding Change for Various Intel® PCI-to-PCI Bridge Products</b> The marking on the chips in products affected will reflect the transition in ownership from "Digital® to "Intel®".	Product Marking
<a href="#">D0000868</a>	Oct 8 1999, updated Apr 1 2002	<b>21554-AA Shipment Tray Transition</b> The trays used for shipping these devices will be changed from the current Daewon* part number 125-3131-913, Rev. A to Daewon* part number 125-3131-913N Rev. B.	Transport Media
<a href="#">D000H042</a>	Oct 8 1999, updated Apr 1 2002	<b>21154-AA, 21154-AB, 21154-BB, 21554-AA 304 PBGA Pin 1 Identification</b> Pin 1 identification on the topside of the PBGA mold cap will be either an ink dot mark or a mold indent. There will be no other changes that affect form/fit/function of the components	Product Marking
<a href="#">D0000798</a>	Oct 8 1999, updated Apr 1 2002	<b>Replacement of Limited Ship Release (LSR) "DC1111C" 21150-BC by "DC1111D" SB21150BC</b> This PCN formalizes a change in the design of the 21150-BC. The new version, SB21150BC (DC1111D) includes a re-layout of the JTAG input signals on six pins.	Design Change

<a href="#">D0000809</a>	Oct 8 1999, updated Apr 1 2002	<b>21154-AB and 21154-BB Shipment Tray Transition</b> Both revisions of the trays meet the JEDEC std. CO-029 for PBGA shipping trays; both carry the same number of chips, and both may withstand temperatures of up to 140 degrees C.	Transport Media
<a href="#">D0000927</a>	Feb 7 2000, updated Apr 1 2002	<b>Product Discontinuance of Intel(R) 21153AC PCI-to-PCI Bridge</b> The product 21153AC will be discontinued, existing functional replacement for the product has been identified per the PCN.	Product Discontinuance
<a href="#">D000G030</a>	Feb 25 2000, updated Apr 1 2002	<b>Revision 1, Product Discontinuance for Selected PCI-to-PCI Bridges</b> Product Discontinuance on 21150AB, 21150BB, 21154AB, 21154BB, 21285AA. See replacement product available in PCN.	Product Discontinuance
<a href="#">D0000944</a>	Mar 8 2000, updated Apr 1 2002	<b>Process Change for the 21050AA PCI-to-PCI Bridge</b> A manufacturing process change to our subcontractor's 0.8micron process has been implemented for the 21050AA.	Process Change
<a href="#">D0000951</a>	Mar 13 2000, updated Apr 1 2002	<b>Package Branding Change for Intel® Bridge Products</b> This package marking change reflects the continued integration of Digital Semiconductor products into Intel standard methodologies	Product Marking
<a href="#">D0000952</a>	Apr 6 2000, updated Apr 1 2002	<b>Intermediate Shipping Box and Moisture Barrier Bag (MBB) label changes</b> Intel will make revisions to the "Bar Code Label" found on: 1) the intermediate shipping box for all Intel products and 2) the Moisture Barrier Bag (MBB) for all Intel's moisture sensitive products. The "Caution Label" found on the Moisture Barrier Bag (MBB) for all Intel's moisture sensitive products will also change.	Transport Media
<a href="#">D0000977</a>	Jun 2 2000, updated Apr 1 2002	<b>Reduction of desiccant pouches</b> Based on the improved Moisture Vapor Transmission Rate (MVTR), Intel will reduce the quantity of desiccant pouches used in packaging moisture sensitive product.	Transport Media
<a href="#">D0000926</a>	Jun 23 2000, updated Apr 1 2002	<b>Cancelled - Discontinuance of Intel(R) 21050AB PCI-to-PCI Bridge</b> This PCN has been cancelled, this product will not be discontinued.	Product Discontinuance
<a href="#">D0000961</a>	Jul 20 2000, updated Apr 1 2002	<b>Plastic Ball Grid Array (PBGA) Relaxation of Coplanarity USL</b> Intel will relax the PBGA package coplanarity USL at RVSI backend, from 6 mils to 8 mils.	Process Change



<a href="#">D0001026</a>	Aug 22 2000, updated Apr 1 2002	<b>Shipping tray conversion for 21050AB, SB21150AC, and SB21150BC</b> The trays used to ship these devices will change from Daewon part number 121-2828-613 to 122-2828-613.	Transport Media
<a href="#">D0001044</a>	Oct 20 2000, updated Apr 1 2002	<b>Discontinuance of Intel S21152BA PCI-to-PCI Bridge and the 21A5204 Evaluation Board</b> S21152BA Intel bridge product has a noise sensitivity that may affect some customer applications. Since Intel cannot predict which customers may have issue, the product is being discontinued immediately. Intel is requesting return of all S21152BA material.	Product Discontinuance
<a href="#">D0000945</a>	Oct 20 2000, updated Apr 1 2002	<b>Discontinuance of Intel 21152-AB PCI-to-PCI Bridge - Extension of Last Order &amp; Last Ship Dates</b> Discontinuance of Intel® 21152AB PCI-to-PCI Bridge, see PCN for replacement product. The last order date has been extended from December 31, 2000 to December 31, 2001; the last shipment date has also been extended from April 30, 2001 to April 30, 2002. The product in question will be discontinued at the given date. This PCN has been cancelled. Many customers have expressed interest in continuing to use this product. The division has obtained manufacturing commitment for three (3) additional years of production. Therefore, the 21152-AB will continue to be available to customers.	Product Discontinuance
<a href="#">D0001125</a>	Aug 30 2001, updated Apr 1 2002	<b>Discontinuance of Intel® 21050-AA PCI-to-PCI Bridge</b> The product above will be discontinued by the milestone dates indicated in this notice due to declining customer demand. The existing functional replacement for this product is the 21050-AB.	Product Discontinuance
<a href="#">D0001252</a>	Sep 27 2001, updated Apr 1 2002	<b>Intel(R) Mobile Processors, PCN 1252-00, FYI, Chipsets, Handheld Component, Flash Memory, Embedded, Platform, and Optical Networking Components, Transport Media, Packing Media</b> Intel will be changing from a white to a silver foil moisture barrier bag (MBB) and, in compliance with new JEDEC requirements, the new Humidity Indicator Cards will have humidity level indicators of 5-10-15 percent.	Transport Media
<a href="#">D0001245</a>	Oct 1 2001, updated Apr 1 2002	<b>21050-AB PCI-to-PCI Bridge, PCN 1245-00, Product Discontinuance</b> Any customer using the S21050AB in existing designs must order sufficient material to satisfy requirements for the remainder of its product life cycle by October 1, 2002.	Product Discontinuance

<a href="#">D0001267</a>	Oct 22 2001, updated Apr 1 2002	<b>21154-AC, 21154-BC PCI-to-PCI Bridge and 21A54-03 Evaluation Board, PCN 1267-00, Form-Fit-Function, Product Conversion, Order Code</b> Intel will be converting the 21154AC and 21154BC PCI-to-PCI Bridge to the FW21154AE and FW21154BE respectively. It will also be converting the 21A5403 Evaluation Board to 21A5404. This product will be unavailable for further orders after January 19, 2002.	Design Change
<a href="#">D0001265</a>	Oct 22 2001, updated Apr 1 2002	<b>21554-AA PCI-to-PCI Bridge and DE1B55401 Evaluation Board, PCN 1265-00, Form-Fit-Function, Product Conversion, Order Code</b> Intel will be converting the 21554-AA PCI-to-PCI Bridge and the DE1B55401 Evaluation Board to the FW21555AA and the DE1B55502 Evaluation Board. This product will be converted and unavailable for additional orders after January 19, 2002.	Design Change
<a href="#">D0001244</a>	Oct 30 2001, updated Apr 1 2002	<b>21152AB PCI-to-PCI Bridge and 21A5203 Evaluation Board, PCN 1244-01, Form-Fit-Function, Product Conversion, Order Code, Revision</b> Revision #1 announces the conversion of the 21152AB to the S21152BB and the 21A5203 Evaluation Board to the 21A5205, replacing the 21152AB product discontinuance. Revision #0 announced the discontinuance of the 21152AB and the 21A5203 Evaluation board.	Design Change
<a href="#">D0102658</a>	Jul 31 2002	<b>SB21150AC/BC, GD21150AC/BC PCI-to-PCI Bridges and 21A5005 Evaluation Board, PCN102658-00, Product Discontinuance</b> Intel Corporation is announcing the discontinuance of the SB21150AC, SB21150BC, GD21150AC, GD21150BC and 21A5005. These products will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date" as noted in the PCN.	Product Discontinuance
<a href="#">D0103053</a>	Jan 20 2003	<b>FW21555AA, FW21555BA PCI-to-PCI Bridge Components and DE1B55502 Evaluation Board, PCN 103053-00, FFF, Stepping Conversion</b> Intel will be converting the FW21555AA PCI-to-PCI Bridge component to the FW21555AB and the FW21555BA component to the FW21555BB. Intel will also be converting the DE1B55502 Evaluation Board to the DE1B55503. The new components will be identical in dimensions to the old component.	Design Change

[Back to Top](#)